

## Carrier Material Report for MSP430F2618TPN

Tray Information:

L - Outer tray length without tabs	ر م	- KO - Outer									
$ \begin{bmatrix} + + + + + + + + + + + + + + + + + + $	W - Outer tray width	tray height									
$\begin{bmatrix} 1 \\ 1 \\ 2 \\ 1 \\ 1 \\ 1 \\ 1 \\ 1 \\ 1 \\ 1 \\$	j ↓										
P1 - Tray unit pocket pitch											
CW - Measurement for tray edge (Y direction) to corner pocket center CL - Measurement for tray edge (X direction) to corner pocket center											

Device	Package	Package	Pins	SPQ	Unit	Max	L (mm)	W (mm)	K0 (µm)	P1 (mm)	CL (mm)	CW
	Drawing	Туре			Array	Temp						(mm)
					Matrix	(°C)						
MSP4	PN	LQFP	80	119	7 x 17	150	315	135.9	7620	17.9	14.3	13.95
30F26												
18TPN												

Images above are just a representation of the carrier. Actual carrier may vary. Please reference the dimensions provided in the table.

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